DISCRETE SEMICONDUCTORS

DATA SHEET

BLW78HF/VHF power transistor

Product specification





BLW78

DESCRIPTION

N-P-N silicon planar epitaxial transistor intended for use in class-A, AB or B operated mobile, industrial and military transmitters in the h.f. and v.h.f. bands. It is resistance stabilized and is guaranteed to withstand severe load mismatch conditions.

It has a $\frac{1}{2}$ " flange envelope with a ceramic cap. All leads are isolated from the flange.

QUICK REFERENCE DATA

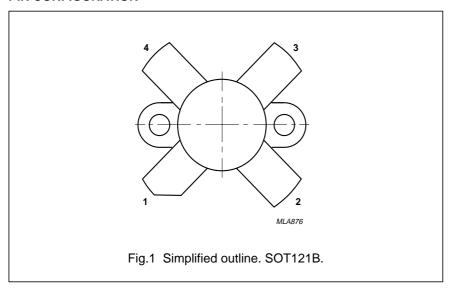
R.F. performance up to $T_h = 25$ °C

MODE OF OPERATION	V _{CE}	I _C I _{C(ZS)} A	f MHz	P _L W	G _p dB	η %	d ₃ ⁽¹⁾ dB	
c.w. (class-B)	28	_	150	100	> 6	> 70	_	
s.s.b. (class-A)	26	3	28	35 (P.E.P.)	typ. 19,5	_	typ. –40	
s.s.b. (class-AB)	28	0,05	28	100 (P.E.P.)	typ. 19,0	typ. 42	typ30	

Note

1. Stated intermodulation distortion figures are referred to the according level of either of the equal amplified tones. Relative to the according peak envelope powers these figures should be increased by 6 dB.

PIN CONFIGURATION



PINNING - SOT121B.

PIN	DESCRIPTION					
1	collector					
2	emitter					
3	base					
4	emitter					

PRODUCT SAFETY This device incorporates beryllium oxide, the dust of which is toxic. The device is entirely safe provided that the BeO disc is not damaged.

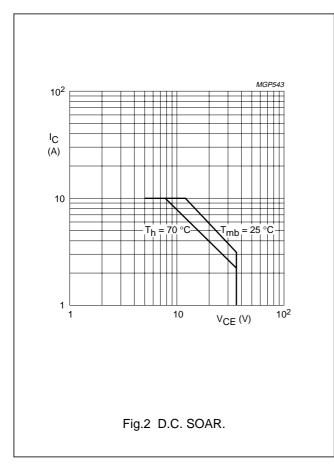
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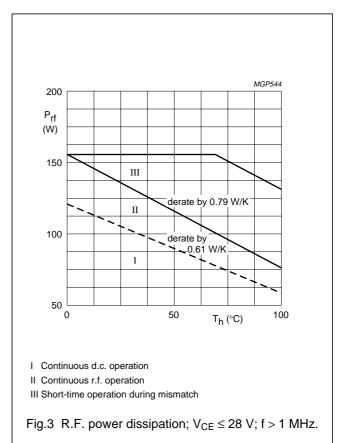
RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

Collector-emitter voltage $(V_{BE} = 0)$

peak value	V_{CESM}	max.	70	V
Collector-emitter voltage (open base)	V_{CEO}	max.	35	V
Emitter-base voltage (open collector)	V_{EBO}	max.	4	V
Collector current (average)	I _{C(AV)}	max.	10	Α
Collector current (peak value); f > 1 MHz	I_{CM}	max.	25	Α
R.F. power dissipation (f > 1 MHz); T_{mb} = 25 °C	P_{rf}	max.	160	W
Storage temperature	T_{stg}	-65 to -	+150	°С
Operating junction temperature	T_j	max.	200	°C





THERMAL RESISTANCE

(dissipation = 80 W; T_{mb} = 86 °C; i.e. T_h = 70 °C)

From junction to mounting base (d.c. dissipation)

From junction to mounting base (r.f. dissipation)

From mounting base to heatsink

 $R_{th j-mb(dc)}$ = 1,45 K/W $R_{th j-mb(rf)}$ = 1,06 K/W

 $R_{th mb-h} = 0.2 \text{ K/W}$

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CHARACTERISTICS

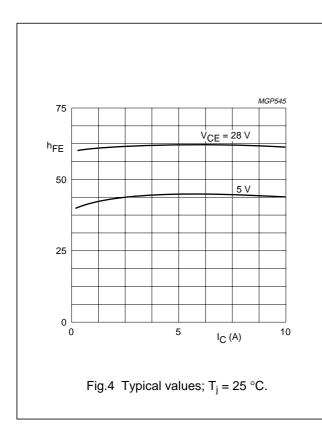
T _j = 25 °C				
Collector-emitter breakdown voltage				
$V_{BE} = 0$; $I_{C} = 50 \text{ mA}$	$V_{(BR)CES}$	>	70	V
Collector-emitter breakdown voltage				
open base; I _C = 100 mA	$V_{(BR)CEO}$	>	35	V
Emitter-base breakdown voltage				
open collector; I _E = 5 mA	$V_{(BR)EBO}$	>	4	V
Collector cut-off current				
$V_{BE} = 0; V_{CE} = 35 \text{ V}$	I _{CES}	<	5	mΑ
D.C. current gain ⁽¹⁾				
$I_C = 5 A; V_{CE} = 5 V$	h _{FE}	20 to	85	
Collector-emitter saturation voltage				
$I_C = 15 \text{ A}; I_B = 3 \text{ A}$	V_{CEsat}	typ.	2	V
Transition frequency at $f = 100 \text{ MHz}^{(2)}$				
$-I_E = 5 \text{ A}; V_{CB} = 28 \text{ V}$	f_{T}	typ.	370	MHz
$-I_E = 15 \text{ A}; V_{CB} = 28 \text{ V}$	f_{T}	typ.	350	MHz
Collector capacitance at f = 1 MHz				
$I_E = I_e = 0; V_{CB} = 28 \text{ V}$	C_c	typ.	155	pF
Feedback capacitance at f = 1 MHz				
$I_C = 100 \text{ mA}; V_{CE} = 28 \text{ V}$	C_{re}	typ.	102	pF
Collector-flange capacitance	C_{cf}	typ.	3	pF

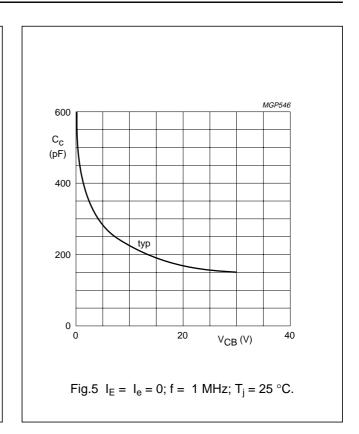
Notes

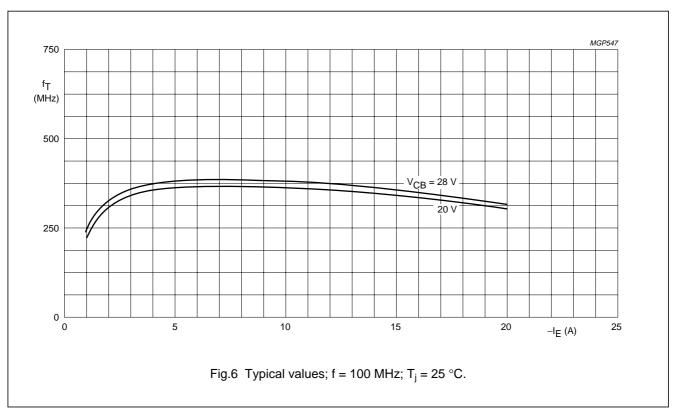
- 1. Measured under pulse conditions: $t_p \le 300~\mu s;~\delta \le 0{,}02.$

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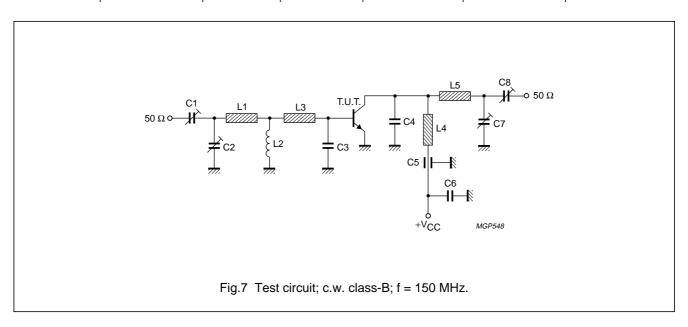
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APPLICATION INFORMATION

R.F. performance in c.w. operation (unneutralized common-emitter class-B circuit); T_h = 25 °C

f (MHz)	V _{CE} (V)	P _L (W)	P _D (W)	η (%)	$\mathbf{z_i}$ (Ω)	\overline{Z}_{L} (Ω)
150	28	100	≤ 25	≥ 70	0,74 + j1,35	4,30 + j0,60



List of components:

C1 = C2 = C7 = C8 = 5 to 100 pF film dielectric trimmer

C3 = 203 pF; 2×82 pF and 39 pF multilayer ceramic chip capacitors (500 V, ATC⁽¹⁾) in parallel

C4 = 39 pF multilayer ceramic chip capacitor (500 V, ATC(1))

C5 = 1 nF feed-through capacitor

C6 = 100 nF polyester capacitor

 $L1 = strip (30 \text{ mm} \times 8 \text{ mm})$; bent to form inverted 'U' shape with top 15 mm above heatsink, and bottom 5 mm above heatsink

 $L2 = 1 \mu H r.f. choke$

L3 = strip; shape as shown in Fig.8; 5 mm above heatsink

 $L4 = strip (40 \text{ mm} \times 8 \text{ mm})$; bent in form _____, 25 mm at 15 mm above heatsink, 5 mm at 5 mm above heatsink

L5 = strip (75 mm long; width 8 mm); 5 mm above base

L1, L3, L4, and L5 are copper strips with a thickness of 0,6 mm.

Heatsink: aluminium; 0,9 K/W

At P_L = 100 W and V_{CE} = 28 V, the output power at heatsink temperatures between 25 °C and 90 °C relative to that at 25 °C is diminished by typ. 0,12 W/K.

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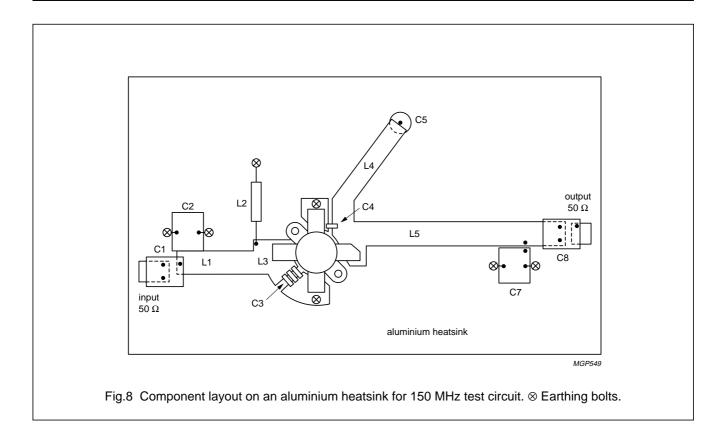
Component layout on an aluminium heatsink for 150 MHz test circuit is shown in Fig.8.

Note

1. ATC means American Technical Ceramics.

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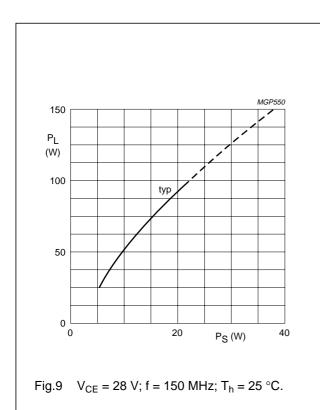
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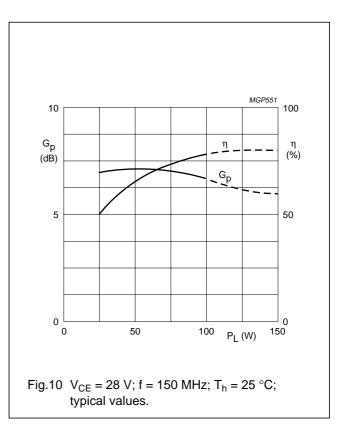


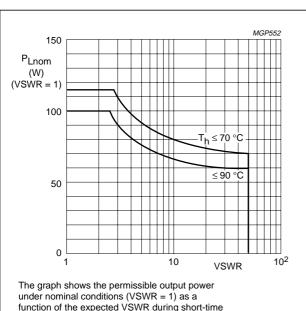
Product specification Philips Semiconductors

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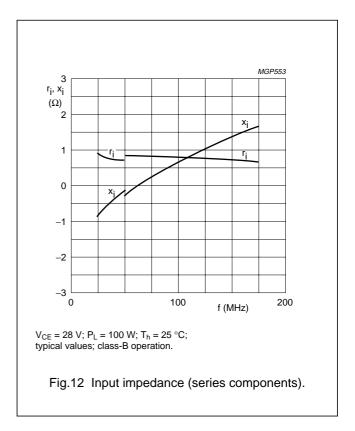


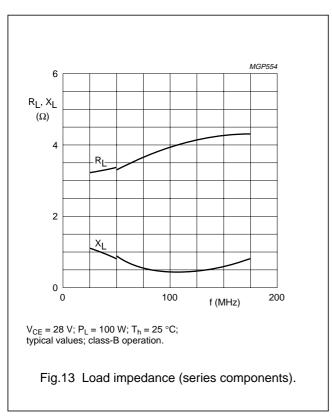
function of the expected VSWR during short-time mismatch conditions with heatsink temperatures as parameter. Fig.11 R.F. SOAR; c.w. class-B operation; $f = 150 \text{ MHz}; V_{CE} = 28 \text{ V};$ $R_{th mb-h} = 0.2 \text{ K/W}.$

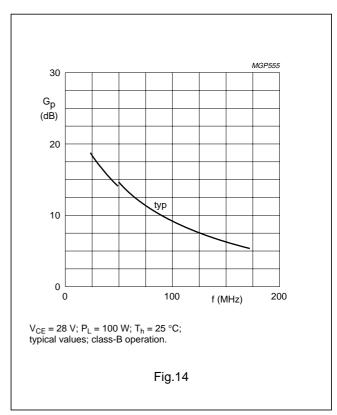
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OPERATING NOTE

Below 50 MHz a base-emitter resistor of 4,7 Ω is recommended to avoid oscillation. This resistor must be effective for r.f. only.







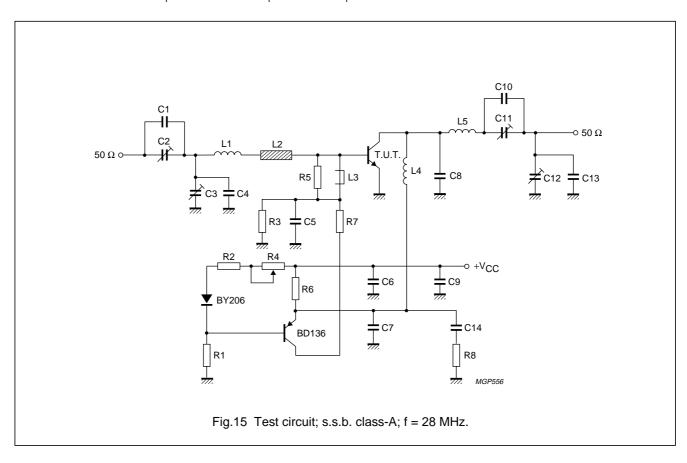
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R.F. performance in s.s.b. class-A operation

 V_{CE} = 26 V; T_h = 40 °C; f_1 = 28,000 MHz; f_2 = 28,001 MHz

OUTPUT POWER	G _p	I _C	d₃
W	dB		dB
35 (P.E.P.)	typ. 19,5	3	typ40



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List of components:

C1 = 33 pF ceramic capacitor (500 V)

C2 = 100 pF air dielectric trimmer (single insulated rotor type)

C3 = 280 pF air dielectric trimmer (single non-insulated rotor type)

C4 = 180 pF polystyrene capacitor

C5 = C6 = C7 = 3,9 nF ceramic capacitor

 $C8 = 2 \times 33$ pF ceramic capacitors in parallel (500 V)

C9 = 330 nF polyester capacitor

C10 = 82 pF ceramic capacitor (500 V)

C11 = 100 pF air dielectric trimmer (single insulated rotor type)

C12 = 180 pF air dielectric trimmer (single non-insulated rotor type)

C13 = 150 pF polystyrene capacitor

C14 = 390 nF polyester capacitor

L1 = 72 nH; 3 turns Cu wire (1,0 mm); int. dia. 7 mm; length 4,8 mm; leads 2×5 mm

L2 = Cu strip (28 mm × 5 mm × 0,2 mm); 18 mm at 3 mm above printed-circuit board

L3 = Ferroxcube choke coil (cat. no. 4312 020 36640)

L4 = 300 nH; 6 turns Cu wire (1,5 mm); int. dia. 12 mm; length 16 mm; leads $2 \times 5 \text{ mm}$

L5 = 330 nH; 7 turns Cu wire (1,5 mm); int. dia. 12 mm; length 20,8 mm; leads 2×5 mm

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R1 = 1,5 k Ω (± 5%) carbon resistor (0,5 W)

R2 = 100 Ω (± 5%) carbon resistor (0,5 W)

R3 = 68 Ω (\pm 5%) carbon resistor (0,5 W)

 $R4 = 100 \Omega$ wirewound potentiometer

R5 = 33 Ω (± 5%) carbon resistor (0,5 W)

R6 = 0,68 Ω (± 10%) wirewound resistor (7 W)

R7 = 120 Ω wirewound resistor (8 W)

R8 = 10 Ω (± 10%) carbon resistor (0,5 W)

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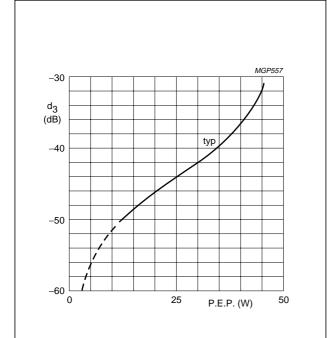


Fig.16 Intermodulation distortion as a function of output power; $V_{CE} = 26$ V; $I_{C} = 3$ A; $f_{1} = 28,000$ MHz; $f_{2} = 28,001$ MHz; $T_{h} = 40$ °C.

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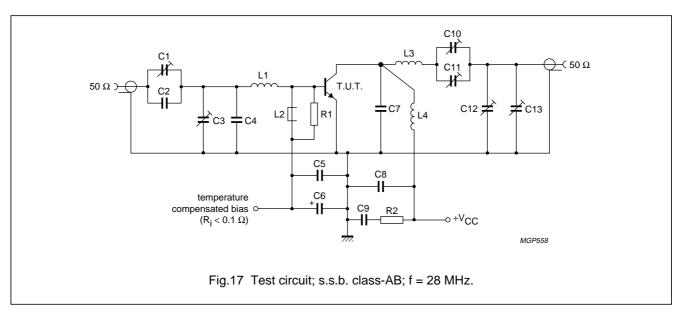
R.F. performance in s.s.b. class-AB operation (linear power amplifier)

 $V_{CE} = 28 \text{ V}$; $T_h = 25 \,^{\circ}\text{C}$; $f_1 = 28,000 \text{ MHz}$; $f_2 = 28,001 \text{ MHz}$

OUTPUT POWER	G _р	η _{dt}	I _C	d ₃ ⁽¹⁾	d ₅ ⁽¹⁾	I _{C(ZS)}
W	dВ	%		dB	dB	mA
100 (P.E.P.)	typ. 19	typ. 42	typ. 4,3	typ30	typ. –37	50

Note

1. Stated intermodulation distortion figures are referred to the according level of either of the equal amplified tones. Relative to the according peak envelope powers these figures should be increased by 6 dB.



List of components:

C1 = C11 = 150 pF air dielectric trimmer (single insulated rotor type)

C2 = 27 pF ceramic capacitor (500 V)

C3 = C12 = 150 pF air dielectric trimmer (single non-insulated rotor type)

C4 = 180 pF ceramic capacitor (500 V)

C5 = C8 = 3,9 nF ceramic capacitor

 $C6 = 150 \mu F/6 V$ solid tantalum capacitor

C7 = 150 pF ceramic capacitor (500 V)

C9 = 100 nF polyester capacitor

C10 = 750 pF mica dielectric trimmer (single insulated rotor type)

C13 = 750 pF mica dielectric trimmer (single non-insulated rotor type)

L1 = 3 turns enamelled Cu wire (1,0 mm); int. dia. 12 mm; length 12 mm

L2 = Ferroxcube wide-band h.f. choke, grade 3B (cat. no. 4312 020 36640)

L3 = 3 turns enamelled Cu wire (2,0 mm); int. dia. 12 mm; length 12 mm

L4 = 2 turns enamelled Cu wire (2,0 mm); int. dia. 12 mm; length 8 mm

R1 = 27 Ω (± 10%) carbon resistor (0,5 W)

R2 = 4,7 Ω (± 10%) carbon resistor (0,5 W)

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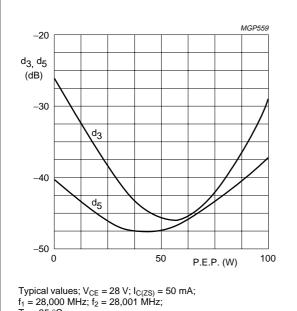
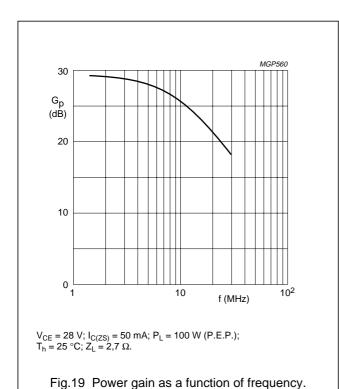
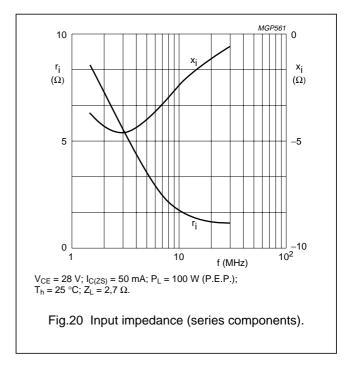


Fig.18 Intermodulation distortion⁽¹⁾ as a function of output power.





Figs 19 and 20 are typical curves and hold for an unneutralized amplifier in s.s.b. class-AB operation.

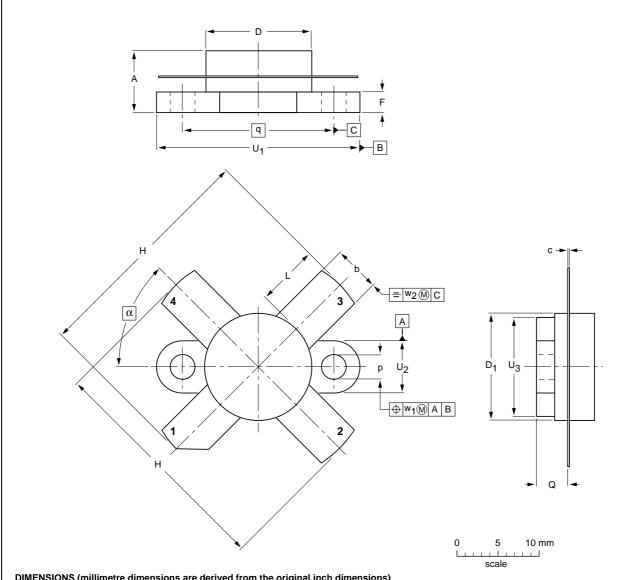
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PACKAGE OUTLINE

Flanged ceramic package; 2 mounting holes; 4 leads

SOT121B



UNIT	A	b	С	D	D ₁	F	н	L	р	Q	q	U ₁	U ₂	U ₃	w ₁	w ₂	α
mm	7.27 6.17	5.82 5.56	0.16 0.10	12.86 12.59	12.83 12.57		28.45 25.52		3.30 3.05	4.45 3.91	18.42	24.90 24.63	6.48 6.22	12.32 12.06	0.51	1.02	45°
inches	0.286 0.243	0.229 0.219	0.006 0.004	0.506 0.496	0.505 0.495	0.105 0.095	1.120 1.005	0.312 0.249	0.130 0.120	0.175 0.154	0.725	0.98 0.97		0.485 0.475		0.04	40"

OUTLINE		REFER	ENCES	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT121B					97-06-28

Product specification Philips Semiconductors

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DEFINITIONS

Data Sheet Status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

LIFE SUPPORT APPLICATIONS

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